International TOR Rectifier

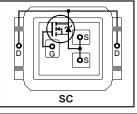
AUTOMOTIVE GRADE

AUIRF7647S2TR AUIRF7647S2TR1

- Advanced Process Technology
- Optimized for Class D Audio Amplifier Applications
- Low Rds(on) for Improved Efficiency
- Low Qg for Better THD and Improved Efficiency
- Low Qrr for Better THD and Lower EMI
- Low Parasitic Inductance for Reduced Ringing and Lower EMI
- Delivers up to 100W per Channel into 8Ω with No Heatsink
- Dual Sided Cooling
- 175°C Operating Temperature
- · Repetitive Avalanche Capability for Robustness and Reliability
- · Lead free, RoHS and Halogen free

DirectFET™ Power MOSFET ②

| V _{(BR)DSS} | 100V |
|--------------------------|----------------|
| R _{DS(on)} typ. | 26m $Ω$ |
| max. | $31 m\Omega$ |
| R _{G (typical)} | 1.6Ω |
| Q _{g (typical)} | 14nC |





Applicable DirectFET Outline and Substrate Outline ①

| SB SC M2 M4 L4 L6 L8 |
|----------------------|
|----------------------|

Description

The AUIRF7647S2TR/TR1 combines the latest Automotive HEXFET® Power MOSFET Silicon technology with the advanced DirectFET packaging platform to produce a best in class part for Automotive Class D audio amplifier applications. The DirectFET package is compatible with existing layout geometries used in power applications, PCB assembly equipment and vapor phase, infra-red or convection soldering techniques, when application note AN-1035 is followed regarding the manufacturing methods and processes. The DirectFET package allows dual sided cooling to maximize thermal transfer in automotive power systems.

This HEXFET Power MOSFET optimizes gate charge, body diode reverse recovery and internal gate resistance to improve key Class D audio amplifier performance factors such as efficiency, THD and EMI. Moreover the DirectFET packaging platform offers low parasitic inductance and resistance when compared to conventional wire bonded SOIC packages which improves EMI performance by reducing the voltage ringing that accompanies current transients. These features combine to make this MOSFET a highly desirable component in Automotive Class D audio amplifier systems.

Absolute Maximum Ratings

| | Parameter | Max. | Units | |
|---------------------------------------|---|---------------------------|----------|--|
| V _{DS} | Drain-to-Source Voltage | 100 | V | |
| V_{GS} | Gate-to-Source Voltage | ± 20 | - V | |
| _D @ T _C = 25°C | Continuous Drain Current, V _{GS} @ 10V (Silicon Limited) | 24 | | |
| _D @ T _C = 100°C | Continuous Drain Current, V _{GS} @ 10V (Silicon Limited) @ | 17 | | |
| D @ T _A = 25°C | Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)3 | 5.9 | A | |
| DM | Pulsed Drain Current ® | 95 | | |
| P _D @T _C = 25°C | Power Dissipation | 41 | w | |
| P _D @T _A = 25°C | Power Dissipation ③ | 2.5 | <u> </u> | |
| AS | Single Pulse Avalanche Energy (Thermally Limited) © | 45 | mJ | |
| AS(tested) | Single Pulse Avalanche Energy (Tested Value) © | 67 | 1113 | |
| AR | Avalanche Current ⑤ | See Fig. 18a,18b,16,17 | Α | |
| E _{AR} | Repetitive Avalanche Energy © | See Fig. 16a, 16b, 16, 17 | mJ | |
| T _P | Peak Soldering Temperature | 270 | | |
| T _J | Operating Junction and | -55 to + 175 | °C | |
| T _{STG} | Storage Temperature Range | | | |

Thermal Resistance

| | Parameter | Тур. | Max. | Units |
|---------------------------|--------------------------|------|------|-------|
| $R_{\theta JA}$ | Junction-to-Ambient ③ | | 60 | |
| $R_{\theta JA}$ | Junction-to-Ambient ® | 12.5 | | |
| $R_{\theta JA}$ | Junction-to-Ambient ® | 20 | | °C/W |
| R _{0J-Can} | Junction-to-Can ⊕® | | 3.7 | |
| $R_{\theta J\text{-PCB}}$ | Junction-to-PCB Mounted | 1.4 | | |
| | Linear Derating Factor ® | 0. | 27 | W/°C |

HEXFET® is a registered trademark of International Rectifier.

Static @ T_J = 25°C (unless otherwise specified)

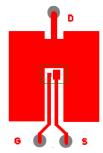
| | Parameter | Min. | Тур. | Max. | Units | Conditions |
|-----------------------------------|--------------------------------------|------|------|------|-------|---|
| V _{(BR)DSS} | Drain-to-Source Breakdown Voltage | 100 | | | V | $V_{GS} = 0V, I_D = 250\mu A$ |
| $\Delta V_{(BR)DSS}/\Delta T_{J}$ | Breakdown Voltage Temp. Coefficient | | 0.10 | | V/°C | Reference to 25°C, I _D = 1mA |
| R _{DS(on)} | Static Drain-to-Source On-Resistance | | 26 | 31 | mΩ | V _{GS} = 10V, I _D = 14A ⑦ |
| V _{GS(th)} | Gate Threshold Voltage | 3.0 | 4.0 | 5.0 | V | $V_{DS} = V_{GS}$, $I_D = 50\mu A$ |
| $\Delta V_{GS(th)}/\Delta T_J$ | Gate Threshold Voltage Coefficient | | -13 | | mV/°C | V _{DS} = V _{GS} , I _D = 30μA |
| gfs | Forward Transconductance | 16 | | | S | $V_{DS} = 25V, I_{D} = 14A$ |
| R _{G(int)} | Internal Gate Resistance | | 1.6 | | Ω | |
| I _{DSS} | Drain-to-Source Leakage Current | | | 20 | μΑ | $V_{DS} = 100V, V_{GS} = 0V$ |
| | | | | 250 | | $V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$ |
| I _{GSS} | Gate-to-Source Forward Leakage | | | 100 | nA | V _{GS} = 20V |
| | Gate-to-Source Reverse Leakage | | | -100 | | $V_{GS} = -20V$ |

Dynamic @ T_J = 25°C (unless otherwise specified)

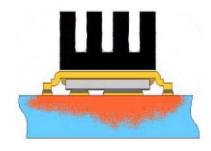
| | Parameter | Min. | Тур. | Max. | Units | Conditions |
|-----------------------|---|------|------|------|-------|--|
| Q_g | Total Gate Charge | | 14 | 21 | | V _{DS} = 50V |
| Q _{gs1} | Pre-Vth Gate-to-Source Charge | | 3.3 | | | V _{GS} = 10V |
| Q _{gs2} | Post-Vth Gate-to-Source Charge | | 1.3 | | nC | I _D = 14A |
| Q_{gd} | Gate-to-Drain Charge | | 5.3 | | l liC | See Fig. 11 |
| Q_godr | Gate Charge Overdrive | | 4.1 | | | |
| Q_{sw} | Switch Charge (Q _{gs2} + Q _{gd}) | | 6.6 | | | |
| Q _{oss} | Output Charge | | 7.6 | | nC | $V_{DS} = 16V, V_{GS} = 0V$ |
| t _{d(on)} | Turn-On Delay Time | | 5.5 | | | $V_{DD} = 50V$ |
| t _r | Rise Time | | 8.4 | | | I _D = 14A |
| t _{d(off)} | Turn-Off Delay Time | | 7.9 | | ns | $R_G = 6.8\Omega$ |
| t _f | Fall Time | | 4.6 | | | V _{GS} = 10V ⑦ |
| C _{iss} | Input Capacitance | | 910 | | | $V_{GS} = 0V$ |
| C _{oss} | Output Capacitance | | 190 | | | V _{DS} = 25V |
| C _{rss} | Reverse Transfer Capacitance | | 47 | | pF | f = 1.0MHz |
| Coss | Output Capacitance | | 960 | | | $V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$ |
| C _{oss} | Output Capacitance | | 115 | | | $V_{GS} = 0V, V_{DS} = 80V, f = 1.0MHz$ |
| C _{oss} eff. | Effective Output Capacitance | | 190 | | | $V_{GS} = 0V, V_{DS} = 0V \text{ to } 80V$ |

Diode Characteristics

| | Parameter | Min. | Тур. | Max. | Units | Conditions |
|-----------------|---------------------------|------|------|------|-------|---|
| I _S | Continuous Source Current | | | 24 | | MOSFET symbol |
| | (Body Diode) | | | 24 | Α | showing the |
| I _{SM} | Pulsed Source Current | | | 95 | Ī | integral reverse |
| | (Body Diode) ^⑤ | | | 95 | | p-n junction diode. |
| V_{SD} | Diode Forward Voltage | | | 1.3 | V | T _J = 25°C, I _S = 14A, V _{GS} = 0V ⑦ |
| t _{rr} | Reverse Recovery Time | | 37 | | ns | $T_J = 25$ °C, $I_F = 14A$, $V_{DD} = 25V$ |
| Q _{rr} | Reverse Recovery Charge | | 55 | | nC | di/dt = 100A/µs ⑦ |



③ Surface mounted on 1 in. square Cu (still air).



Mounted to a PCB with small clip heatsink (still air)



 Mounted on minimum footprint full size board with metalized back and with small clip heatsink (still air)

Qualification Information[†]

| | | Automotive | | | |
|-----------------------------|------------------|--|------------------------------|--|--|
| | | | (per AEC-Q101) ^{††} | | |
| Qualification Level | | Comments: This part number(s) passed Automotive qualification IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level. | | | |
| Moisture Sensitivity | Level | DFET2 MSL1 | | | |
| | Machine Model | | M4 (>400V) | | |
| | | AEC-Q101-002 | | | |
| ESD | Human Body Model | H1A (≤500V) | | | |
| ESD | | | AEC-Q101-001 | | |
| | Charged Device | C4 (≤1000V) | | | |
| | Model | AEC-Q101-005 | | | |
| RoHS Compliant | • | Yes | | | |

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com

^{††} Exceptions to AEC-Q101 requirements are noted in the qualification report.

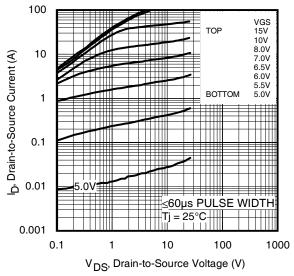


Fig 1. Typical Output Characteristics

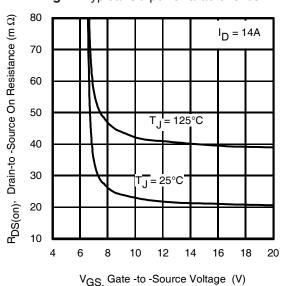


Fig 3. Typical On-Resistance vs. Gate Voltage

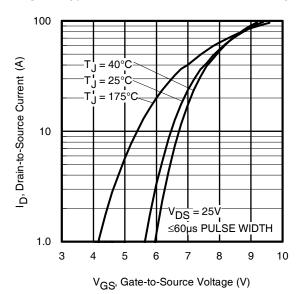


Fig 5. Typical Transfer Characteristics

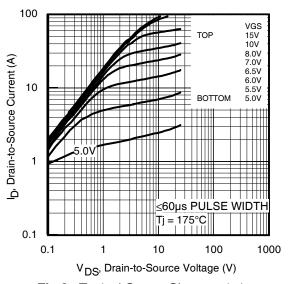


Fig 2. Typical Output Characteristics

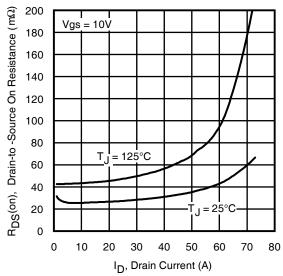


Fig 4. Typical On-Resistance vs. Drain Current

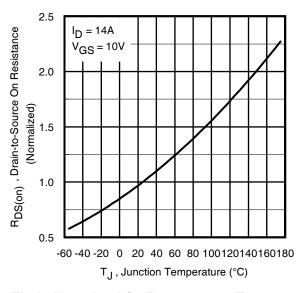


Fig 6. Normalized On-Resistance vs. Temperature

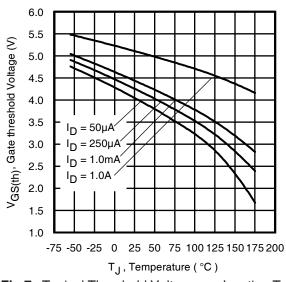


Fig 7. Typical Threshold Voltage vs. Junction Temperature

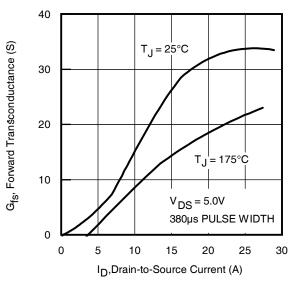


Fig 9. Typical Forward Transconductance vs. Drain Current

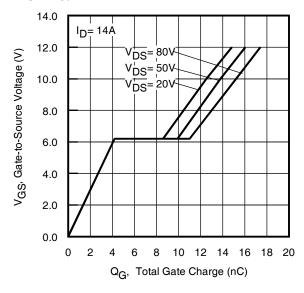


Fig.11 Typical Gate Charge vs.Gate-to-Source Voltage www.irf.com

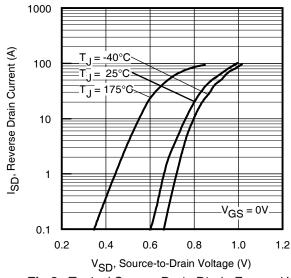


Fig 8. Typical Source-Drain Diode Forward Voltage

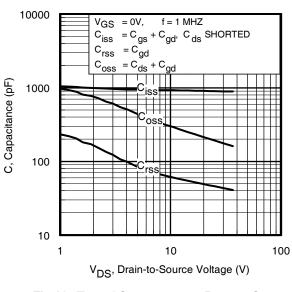


Fig 10. Typical Capacitance vs.Drain-to-Source Voltage

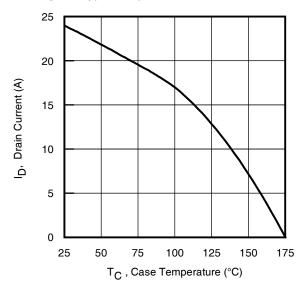


Fig 12. Maximum Drain Current vs. Case Temperature

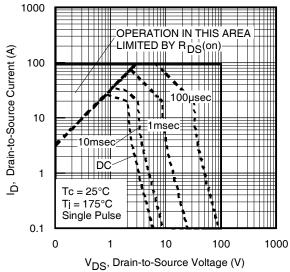


Fig 13. Maximum Safe Operating Area

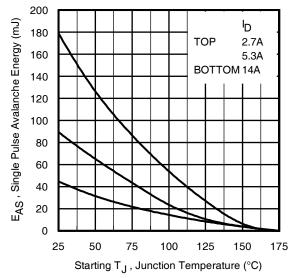


Fig 14. Maximum Avalanche Energy vs. Temperature

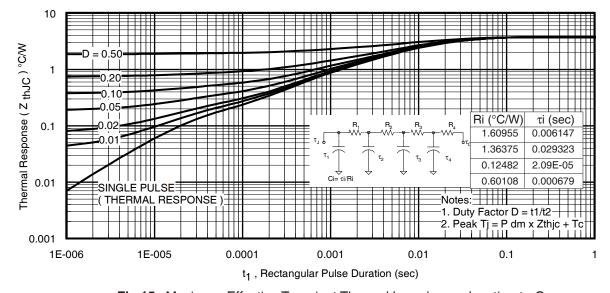


Fig 15. Maximum Effective Transient Thermal Impedance, Junction-to-Case

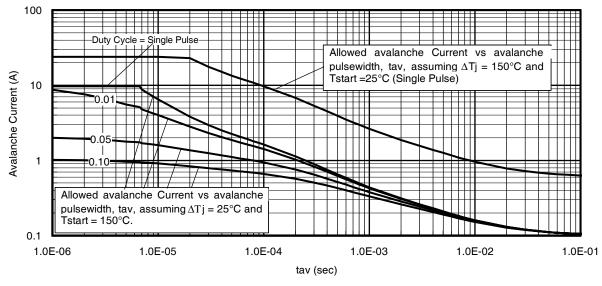


Fig 16. Typical Avalanche Current vs. Pulsewidth

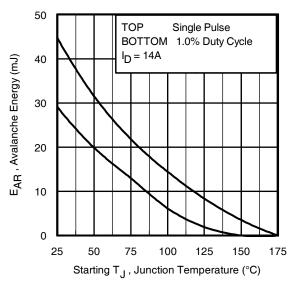


Fig 17. Maximum Avalanche Energy vs. Temperature

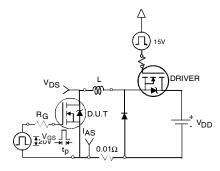


Fig 18a. Unclamped Inductive Test Circuit

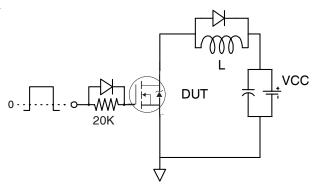


Fig 19a. Gate Charge Test Circuit

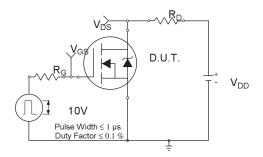


Fig 20a. Switching Time Test Circuit

Notes on Repetitive Avalanche Curves , Figures 16, 17: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption: Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for
- 2. Safe operation in Avalanche is allowed as long asT_{imax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 18a, 18b.
- 4. P_{D (ave)} = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 16, 17).
 - t_{av =} Average time in avalanche.
 - D = Duty cycle in avalanche = $t_{av} \cdot f$

 $Z_{th,IC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D \; (ave)} &= 1/2 \; (\; 1.3 \cdot BV \cdot I_{aV}) = \Delta T / \; Z_{th,JC} \\ I_{av} &= 2\Delta T / \; [1.3 \cdot BV \cdot Z_{th}] \\ E_{AS \; (AR)} &= P_{D \; (ave)} \cdot t_{av} \end{split}$$

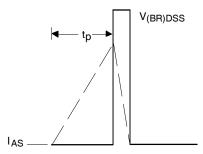


Fig 18b. Unclamped Inductive Waveforms

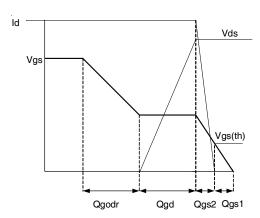


Fig 19b. Gate Charge Waveform

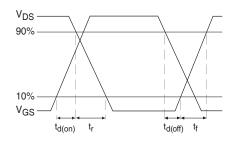
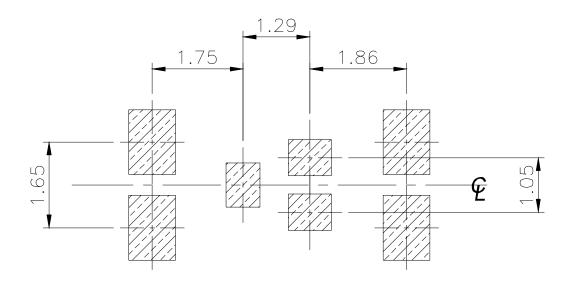
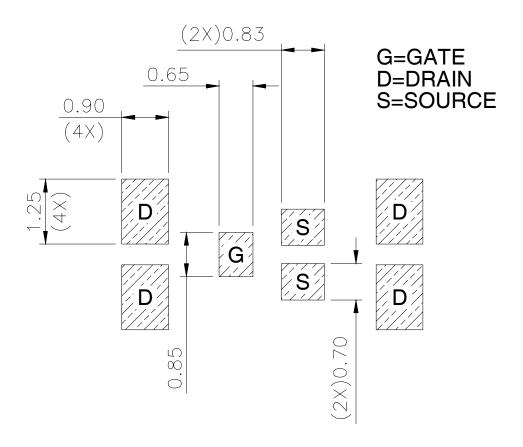


Fig 20b. Switching Time Waveforms

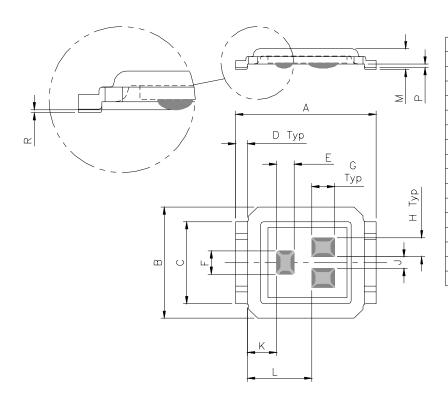
Automotive DirectFET™ Board Footprint, SC (Small Size Can).

Please see AN-1035 for DirectFET assembly details and stencil and substrate design recommendations



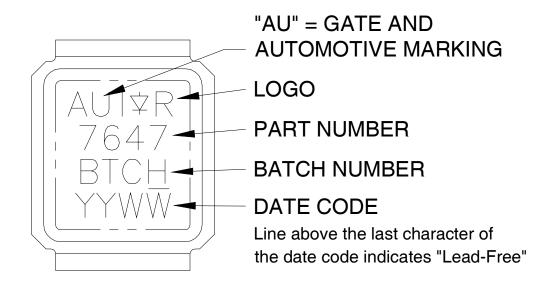


Automotive DirectFET™ Outline Dimension, SC Outline (Small Size Can). Please see AN-1035 for DirectFET assembly details and stencil and substrate design recommendations

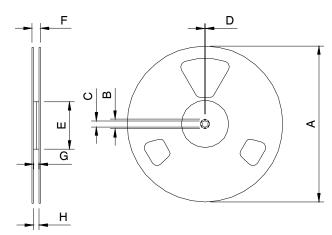


| | DII | MENSI | ONS | | | |
|------|--------|-------|--------------|-------|--|--|
| | METRIC | | TRIC IMPERIA | | | |
| CODE | MIN | MAX | MIN | MAX | | |
| Α | 4.75 | 4.85 | 0.187 | 0.191 | | |
| В | 3.70 | 3.95 | 0.146 | 0.156 | | |
| О | 2.75 | 2.85 | 0.108 | 0.112 | | |
| D | 0.35 | 0.45 | 0.014 | 0.018 | | |
| Е | 0.58 | 0.62 | 0.023 | 0.024 | | |
| F | 0.78 | 0.82 | 0.031 | 0.032 | | |
| G | 0.75 | 0.80 | 0.030 | 0.031 | | |
| Н | 0.63 | 0.67 | 0.025 | 0.026 | | |
| J | 0.38 | 0.42 | 0.015 | 0.016 | | |
| K | 0.95 | 1.05 | 0.037 | 0.041 | | |
| L | 2.15 | 2.25 | 0.085 | 0.088 | | |
| М | 0.68 | 0.74 | 0.027 | 0.029 | | |
| Р | 0.08 | 0.17 | 0.003 | 0.007 | | |
| R | 0.02 | 0.08 | 0.001 | 0.003 | | |

Automotive DirectFET™ Part Marking

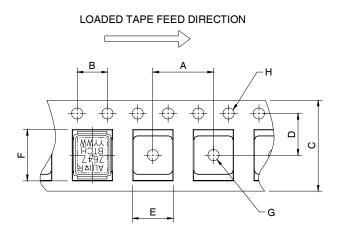


Automotive DirectFET™ Tape & Reel Dimension (Showing component orientation).



NOTE: Controlling dimensions in mm Std reel quantity is 4800 parts. (ordered as AUIRF7647S2TR). For 1000 parts on 7" reel, order AUIRF7647S2TR1

| REEL DIMENSIONS | | | | | | | | |
|----------------------------|-------|------|--------|-------|-----------------------|-------|-------|-------|
| STANDARD OPTION (QTY 4800) | | | | | TR1 OPTION (QTY 1000) | | | |
| | ME | TRIC | IMP | ERIAL | ME | ETRIC | IMP | ERIAL |
| CODE | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX |
| Α | 330.0 | N.C | 12.992 | N.C | 177.77 | N.C | 6.9 | N.C |
| В | 20.2 | N.C | 0.795 | N.C | 19.06 | N.C | 0.75 | N.C |
| С | 12.8 | 13.2 | 0.504 | 0.520 | 13.5 | 12.8 | 0.53 | 0.50 |
| D | 1.5 | N.C | 0.059 | N.C | 1.5 | N.C | 0.059 | N.C |
| Е | 100.0 | N.C | 3.937 | N.C | 58.72 | N.C | 2.31 | N.C |
| F | N.C | 18.4 | N.C | 0.724 | N.C | 13.50 | N.C | 0.53 |
| G | 12.4 | 14.4 | 0.488 | 0.567 | 11.9 | 12.01 | 0.47 | N.C |
| Н | 11.9 | 15.4 | 0.469 | 0.606 | 11.9 | 12.01 | 0.47 | N.C |



NOTE: CONTROLLING DIMENSIONS IN MM

| DIMENSIONS | | | | | | | | |
|------------|-------|-------|-------|-------|--|--|--|--|
| | MET | RIC | IMPE | RIAL | | | | |
| CODE | MIN | MAX | MIN | MAX | | | | |
| Α | 7.90 | 8.10 | 0.311 | 0.319 | | | | |
| В | 3.90 | 4.10 | 0.154 | 0.161 | | | | |
| С | 11.90 | 12.30 | 0.469 | 0.484 | | | | |
| D | 5.45 | 5.55 | 0.215 | 0.219 | | | | |
| E | 4.00 | 4.20 | 0.158 | 0.165 | | | | |
| F | 5.00 | 5.20 | 0.197 | 0.205 | | | | |
| G | 1.50 | N.C | 0.059 | N.C | | | | |
| Н | 1.50 | 1 60 | 0.059 | 0.063 | | | | |

Notes:

- $\ensuremath{\mathbb{O}}$ Click on this section to link to the appropriate technical paper.
- ② Click on this section to link to the DirectFET Website.
- ③ Surface mounted on 1 in. square Cu board, steady state.
- ④ T_C measured with thermocouple mounted to top (Drain) of part.
- ⑤ Repetitive rating; pulse width limited by max. junction temperature.
- © Starting $T_J = 25$ °C, L = 0.46mH, $R_G = 25\Omega$, $I_{AS} = 14$ A.
- ⑦ Pulse width ≤ 400 μ s; duty cycle ≤ 2%.
- ® Used double sided cooling, mounting pad with large heatsink.
- Mounted on minimum footprint full size board with metalized back and with small clip heatsink.
- $\ensuremath{\mathbb{O}}$ $\ensuremath{\mathbb{R}}_\theta$ is measured at $\ensuremath{\mathtt{T}}_{\ensuremath{\mathtt{J}}}$ of approximately 90°C.

International

TOR Rectifier

AUIRF7647S2TR/TR1

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For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

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